

Docket No. 56237-DIV (71987)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

APPLICANT: C. Huang

U.S.S.N.: Not Yet Assigned [Divisional of U.S. Serial No. 09/908,236]

FILED: Herewith

FOR: SEMICONDUCTOR PACKAGE AND FABRICATING METHOD  
THEREOF

.....

**CERTIFICATE OF EXPRESS MAILING**

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on this date July 25, 2003 in an envelope as "Express Mail Post Office to Addressee," mailing Label Number EV343734470US addressed to the: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

By: Michelle P. Chicos  
Michelle P. Chicos

.....

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**PRELIMINARY AMENDMENT**

Applicant kindly requests that the above-identified application be amended as follows:

**IN THE SPECIFICATION**

Please add the following on page 1 after the title:

**CROSS-REFERENCE TO RELATED APPLICATION(S)**

This application is a divisional of copending application U.S. Serial No. 09/908,236, filed on July 18, 2001.